

## OptiMOS™3 Power-Transistor

### Features

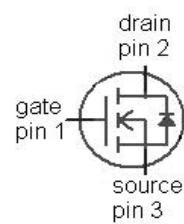
- N-channel, normal level
- Excellent gate charge  $\times R_{DS(on)}$  product (FOM)
- Very low on-resistance  $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC<sup>1)</sup> for target application
- Ideal for high-frequency switching and synchronous rectification
- Halogen-free according to IEC61249-2-21

### Product Summary

$V_{DS}$	100	V
$R_{DS(on),max}$	12.6	mΩ
$I_D$	35	A



Type	IPA126N10N3 G
Package	PG-T0220-FP
Marking	126N10N



**Maximum ratings**, at  $T_j=25$  °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	$I_D$	$T_c=25$ °C <sup>2)</sup>	35	A
		$T_c=100$ °C	25	
Pulsed drain current <sup>2)</sup>	$I_{D,pulse}$	$T_c=25$ °C	140	
Avalanche energy, single pulse	$E_{AS}$	$I_D=35$ A, $R_{GS}=25$ Ω	90	mJ
Gate source voltage	$V_{GS}$		±20	V
Power dissipation	$P_{tot}$	$T_c=25$ °C	33	W
Operating and storage temperature	$T_j, T_{stg}$		-55 ... 175	°C
IEC climatic category; DIN IEC 68-1			55/175/56	

<sup>1)</sup>J-STD20 and JESD22

<sup>2)</sup> See figure 3

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

**Thermal characteristics**

Thermal resistance, junction - case	$R_{thJC}$		-	-	4.5	K/W
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**Electrical characteristics**, at  $T_j=25$  °C, unless otherwise specified

**Static characteristics**

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0$ V, $I_D=1$ mA	100	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_D=45$ µA	2	2.7	3.5	
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=100$ V, $V_{GS}=0$ V, $T_j=25$ °C	-	0.1	1	µA
		$V_{DS}=100$ V, $V_{GS}=0$ V, $T_j=125$ °C	-	10	100	
Gate-source leakage current	$I_{GSS}$	$V_{GS}=20$ V, $V_{DS}=0$ V	-	1	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=10$ V, $I_D=35$ A	-	10.9	12.6	mΩ
		$V_{GS}=6$ V, $I_D=18$ A	-	13.5	24	
Gate resistance	$R_G$		-	1.1	-	Ω
Transconductance	$g_{fs}$	$ V_{DS} >2 I_D R_{DS(on)max}$ , $I_D=35$ A	25	50	-	s

<sup>3)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

**Dynamic characteristics**

Input capacitance	$C_{iss}$	$V_{GS}=0 \text{ V}, V_{DS}=50 \text{ V}, f=1 \text{ MHz}$	-	1880	2500	pF
Output capacitance	$C_{oss}$		-	330	439	
Reverse transfer capacitance	$C_{rss}$		-	14	-	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=50 \text{ V}, V_{GS}=10 \text{ V}, I_D=35 \text{ A}, R_{G,ext}=1.6 \Omega$	-	12	-	ns
Rise time	$t_r$		-	6	-	
Turn-off delay time	$t_{d(off)}$		-	20	-	
Fall time	$t_f$		-	4	-	

**Gate Charge Characteristics<sup>4)</sup>**

Gate to source charge	$Q_{gs}$	$V_{DD}=50 \text{ V}, I_D=35 \text{ A}, V_{GS}=0 \text{ to } 10 \text{ V}$	-	9	-	nC
Gate to drain charge	$Q_{gd}$		-	5	-	
Switching charge	$Q_{sw}$		-	8	-	
Gate charge total	$Q_g$		-	26	35	
Gate plateau voltage	$V_{plateau}$		-	4.7	-	V
Output charge	$Q_{oss}$		$V_{DD}=50 \text{ V}, V_{GS}=0 \text{ V}$	-	35	46 nC

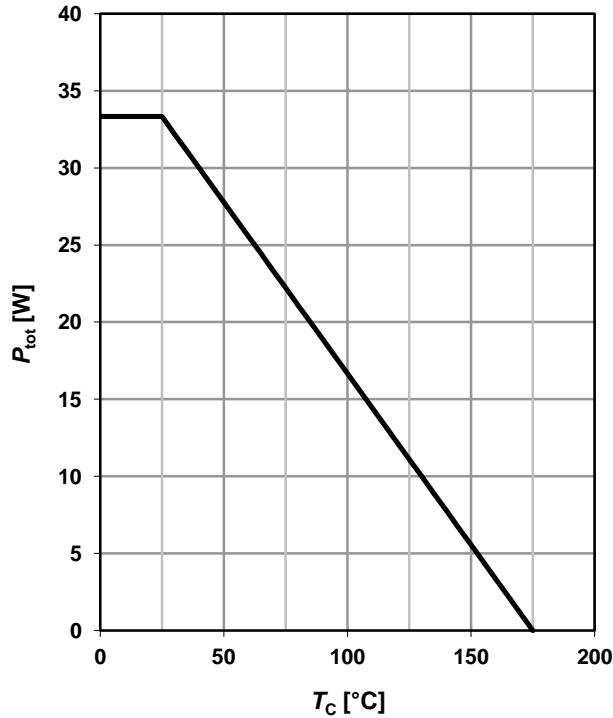
**Reverse Diode**

Diode continuous forward current	$I_S$	$T_C=25 \text{ }^\circ\text{C}$	-	-	35	A
Diode pulse current	$I_{S,pulse}$		-	-	140	
Diode forward voltage	$V_{SD}$	$V_{GS}=0 \text{ V}, I_F=35 \text{ A}, T_j=25 \text{ }^\circ\text{C}$	-	0.9	1.2	V
Reverse recovery time	$t_{rr}$	$V_R=50 \text{ V}, I_F=35 \text{ A}, di_F/dt=100 \text{ A}/\mu\text{s}$	-	58	-	ns
Reverse recovery charge	$Q_{rr}$		-	114	-	nC

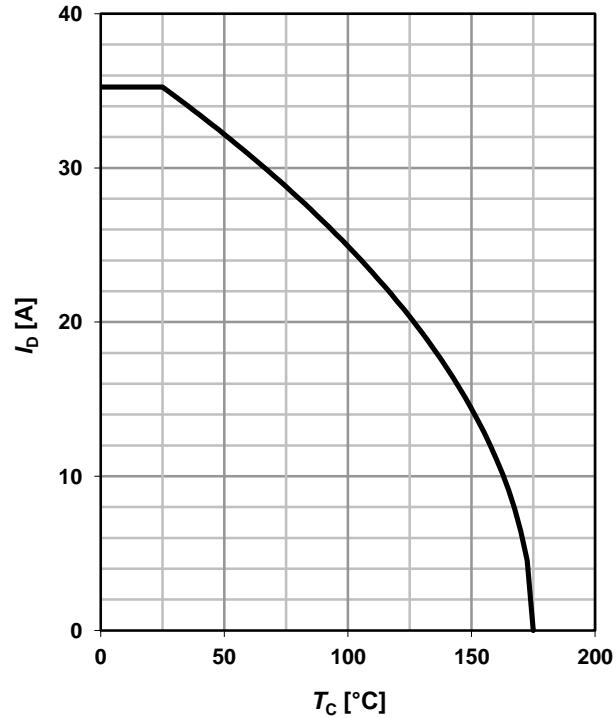
<sup>4)</sup> See figure 16 for gate charge parameter definition

**1 Power dissipation**

$$P_{\text{tot}} = f(T_C)$$

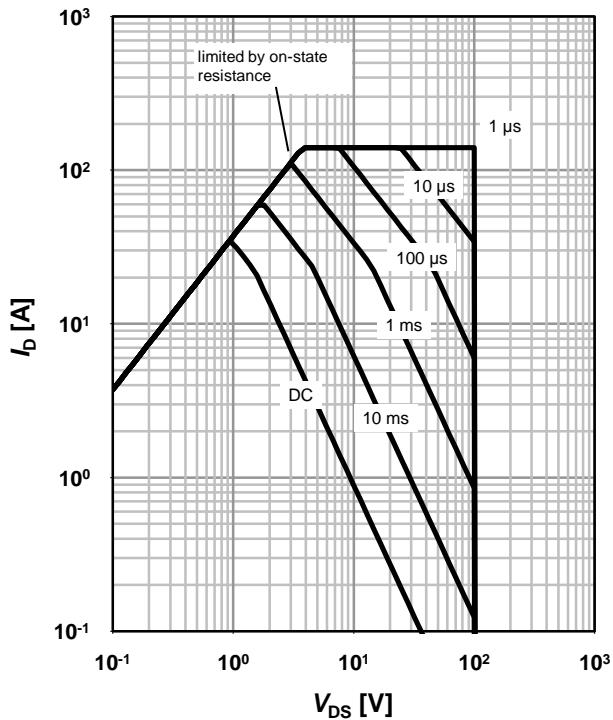

**2 Drain current**

$$I_D = f(T_C); V_{GS} \geq 10 \text{ V}$$


**3 Safe operating area**

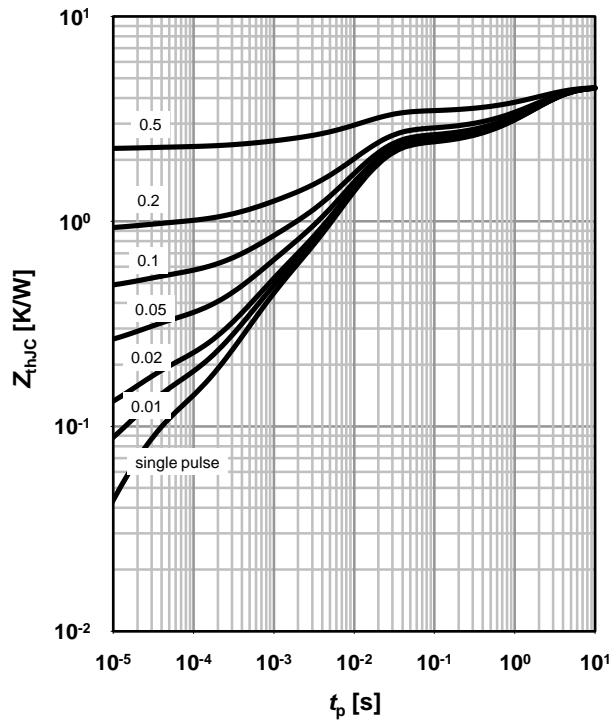
$$I_D = f(V_{DS}); T_C = 25 \text{ } ^{\circ}\text{C}; D = 0$$

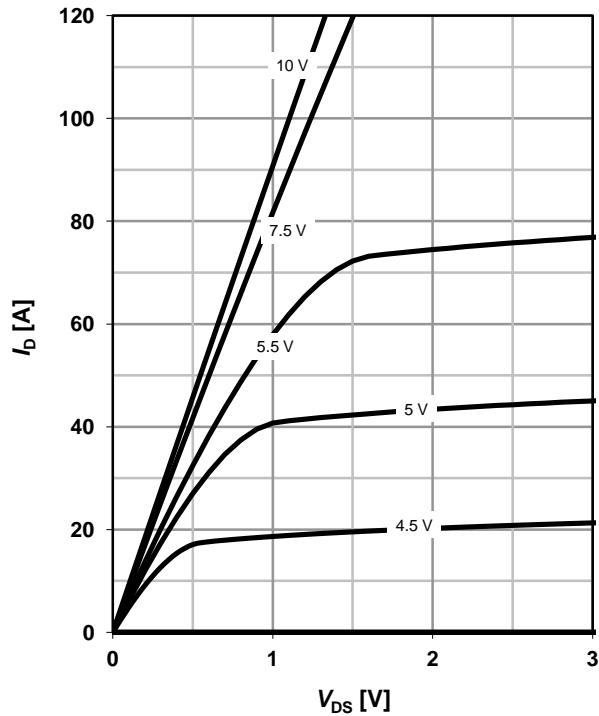
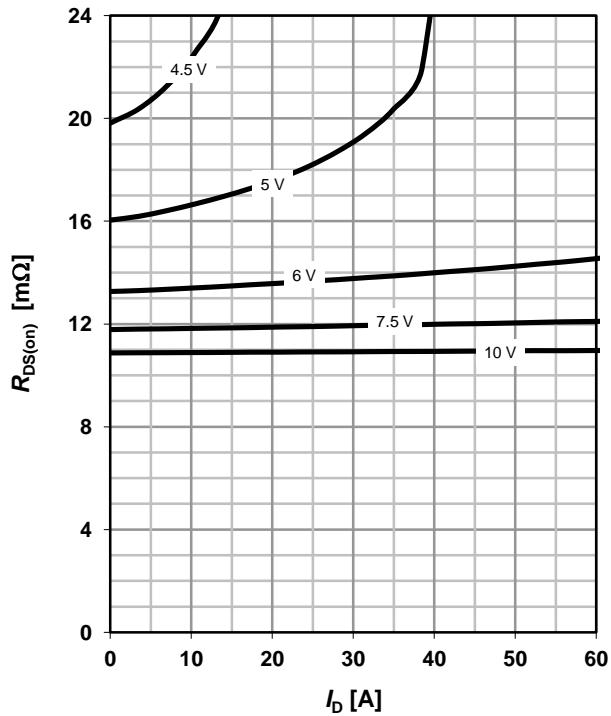
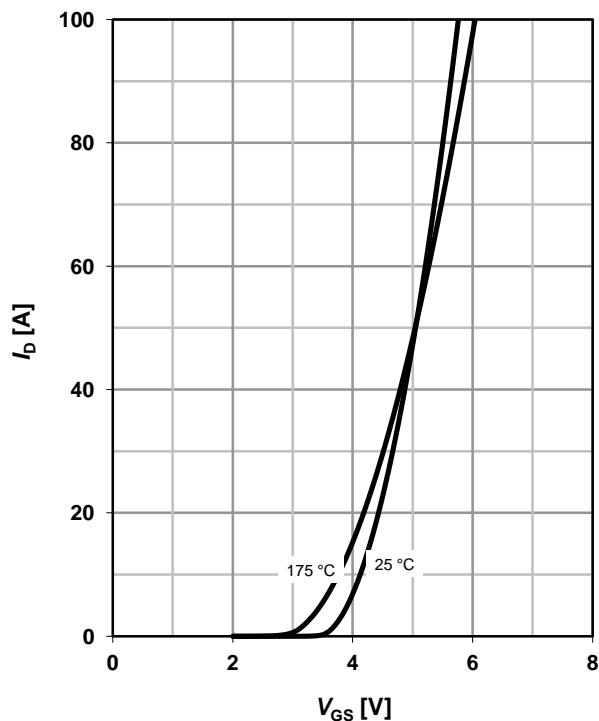
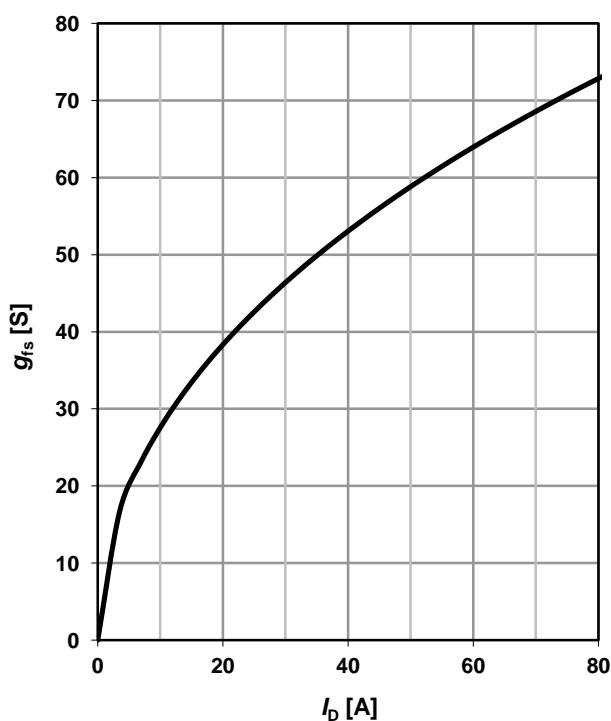
parameter:  $t_p$

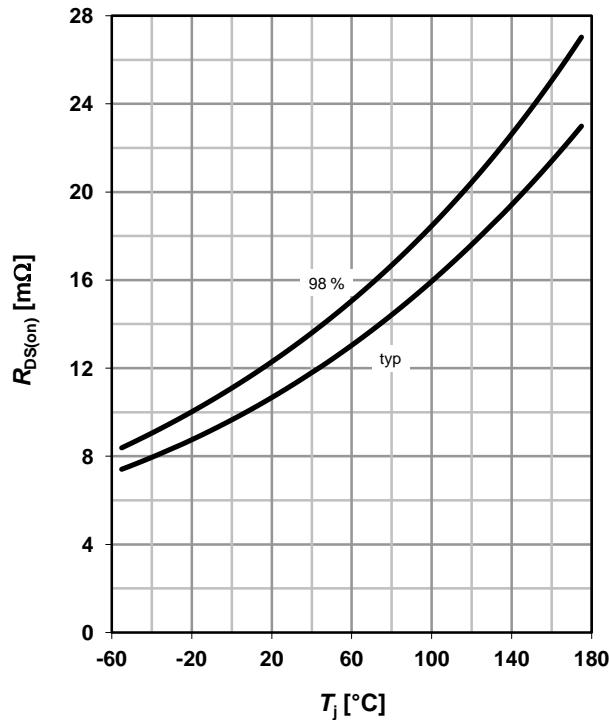

**4 Max. transient thermal impedance**

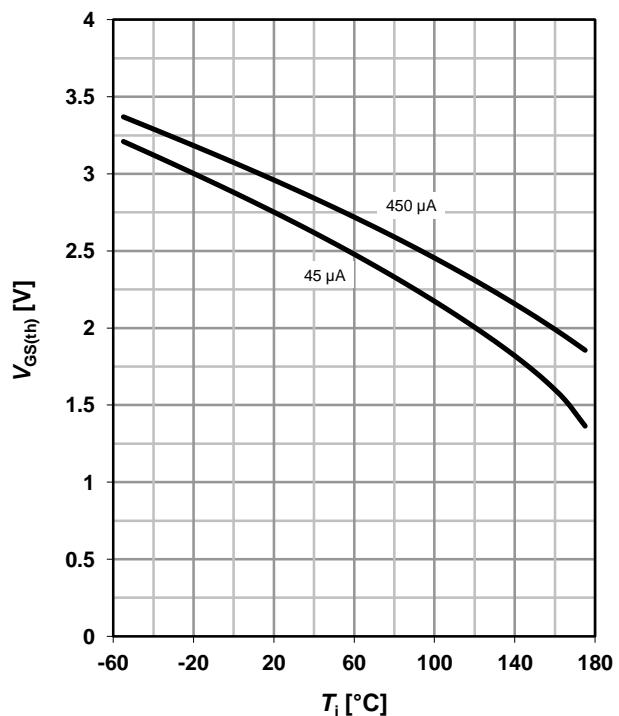
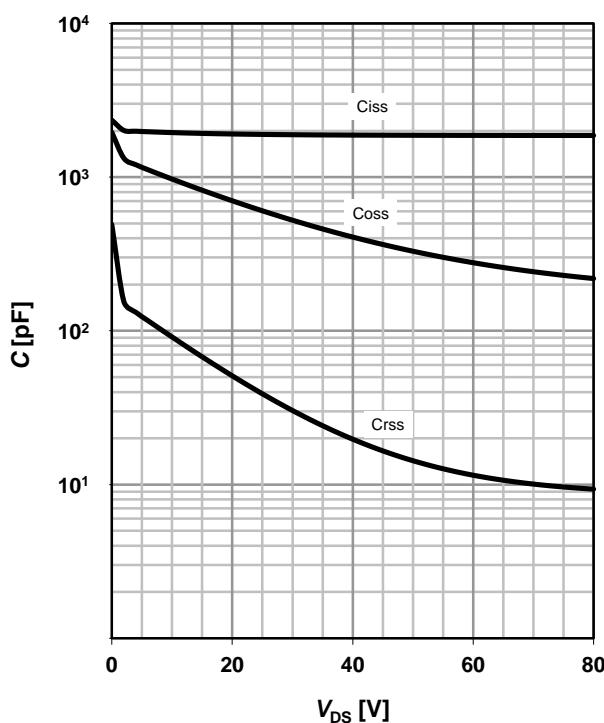
$$Z_{\text{thJC}} = f(t_p)$$

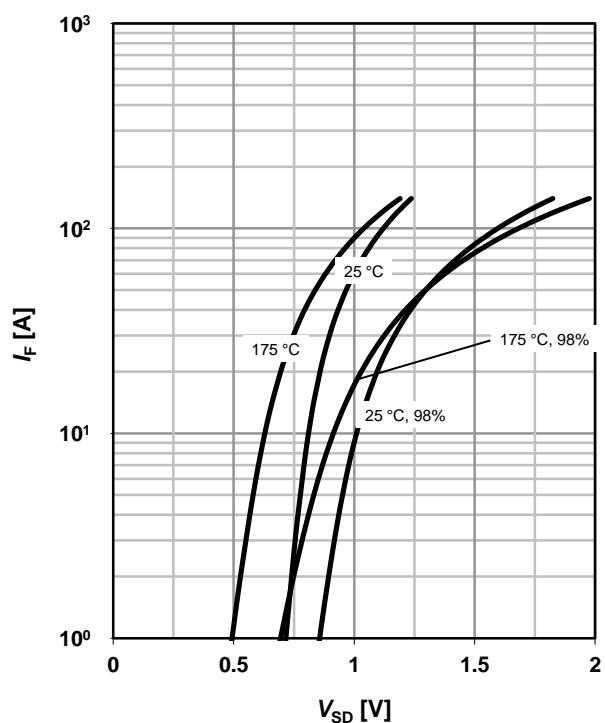
parameter:  $D = t_p/T$



**5 Typ. output characteristics**
 $I_D=f(V_{DS})$ ;  $T_j=25\text{ }^\circ\text{C}$ 
parameter:  $V_{GS}$ 
**6 Typ. drain-source on resistance**
 $R_{DS(on)}=f(I_D)$ ;  $T_j=25\text{ }^\circ\text{C}$ 
parameter:  $V_{GS}$ 
**7 Typ. transfer characteristics**
 $I_D=f(V_{GS})$ ;  $|V_{DS}|>2|I_D|R_{DS(on)max}$ 
parameter:  $T_j$ 
**8 Typ. forward transconductance**
 $g_{fs}=f(I_D)$ ;  $T_j=25\text{ }^\circ\text{C}$ 


**9 Drain-source on-state resistance**
 $R_{DS(on)} = f(T_j); I_D = 35 \text{ A}; V_{GS} = 10 \text{ V}$ 

**10 Typ. gate threshold voltage**
 $V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$ 

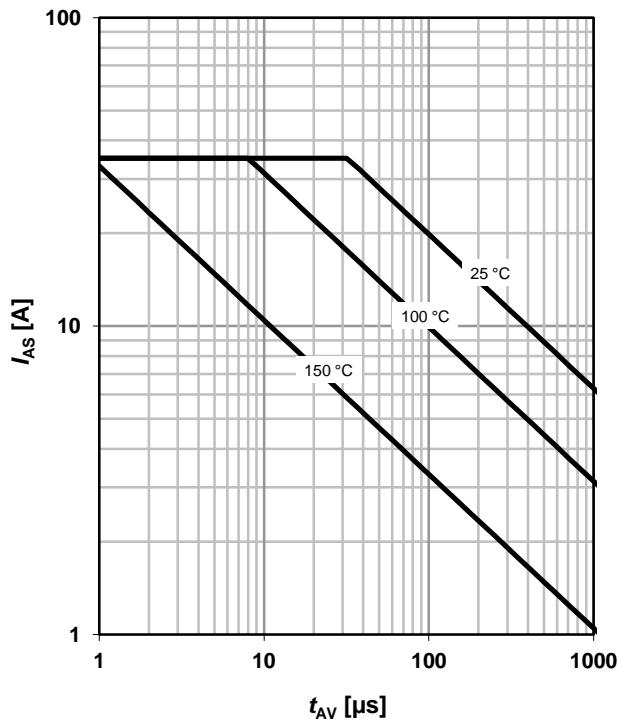
 parameter:  $I_D$ 

**11 Typ. capacitances**
 $C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$ 

**12 Forward characteristics of reverse diode**
 $I_F = f(V_{SD})$ 

 parameter:  $T_j$ 


### 13 Avalanche characteristics

$I_{AS}=f(t_{AV})$ ;  $R_{GS}=25 \Omega$

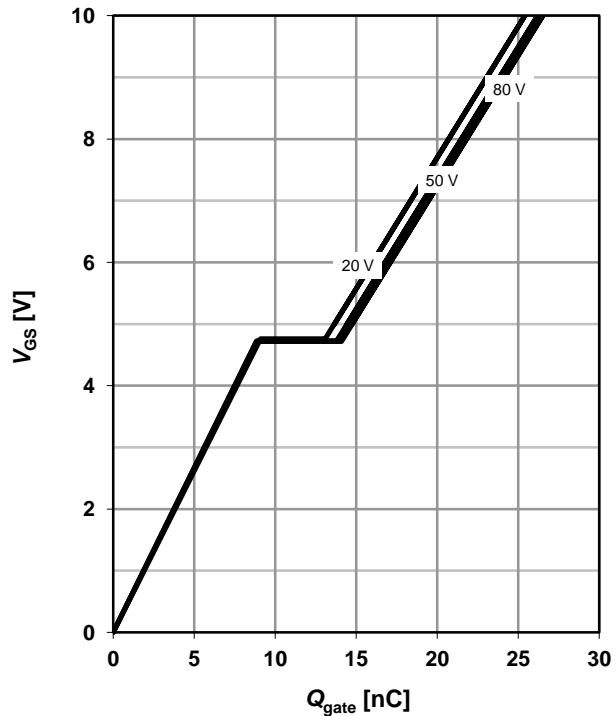
parameter:  $T_{j(\text{start})}$



### 14 Typ. gate charge

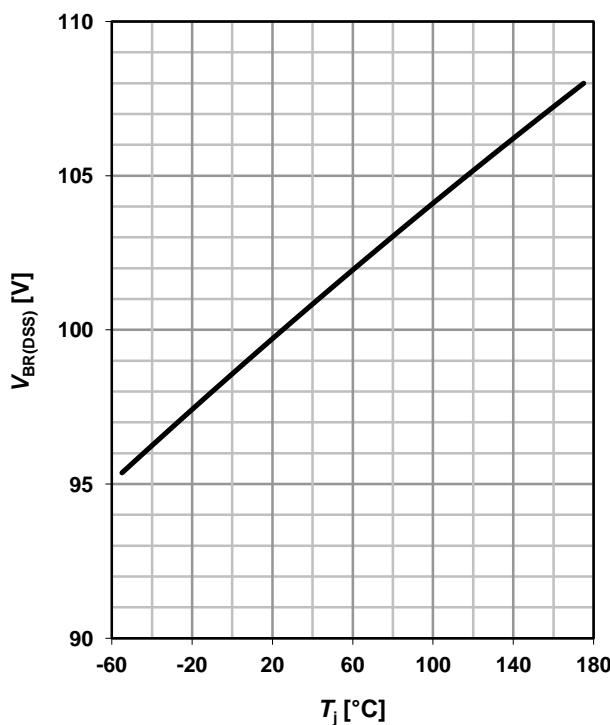
$V_{GS}=f(Q_{\text{gate}})$ ;  $I_D=35 \text{ A pulsed}$

parameter:  $V_{DD}$

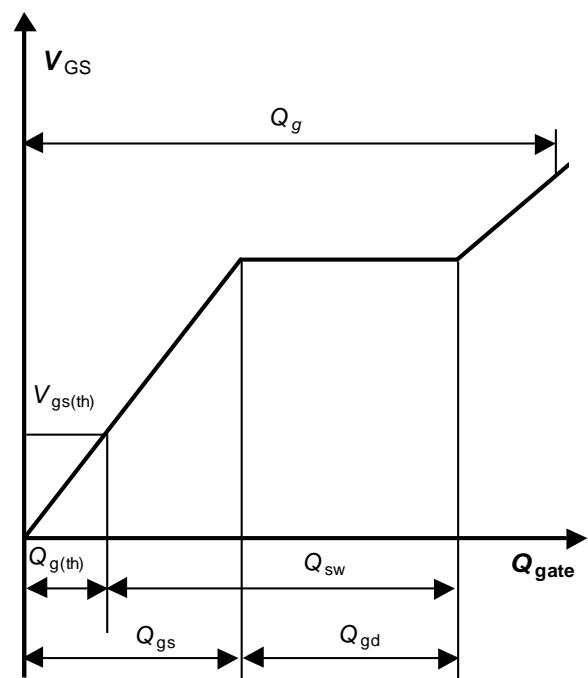


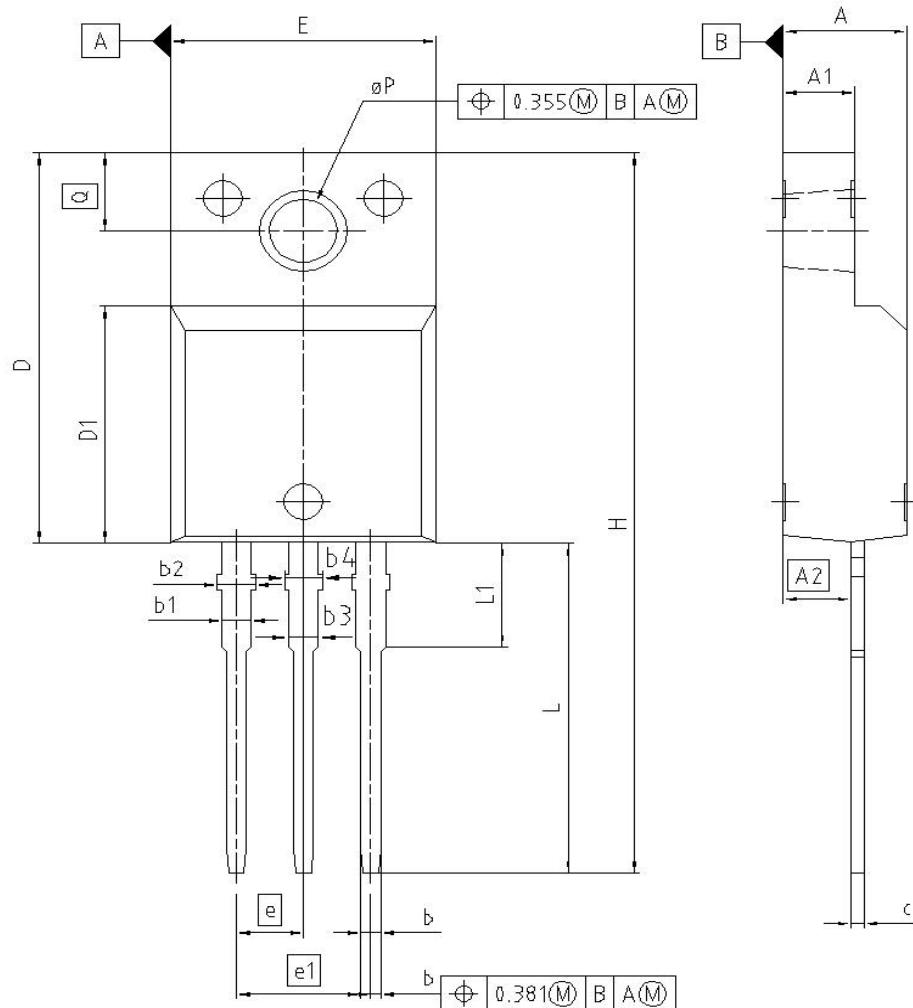
### 15 Drain-source breakdown voltage

$V_{BR(DSS)}=f(T_j)$ ;  $I_D=1 \text{ mA}$



### 16 Gate charge waveforms



**PG-T0220-FP**


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
<b>A</b>	4.55	4.85	0.179	0.191
<b>A1</b>	2.55	2.85	0.100	0.112
<b>A2</b>	2.42	2.72	0.095	0.107
<b>b</b>	0.65	0.85	0.026	0.033
<b>b1</b>	0.95	1.33	0.037	0.052
<b>b2</b>	0.95	1.51	0.037	0.059
<b>b3</b>	0.65	1.33	0.026	0.052
<b>b4</b>	0.65	1.51	0.026	0.059
<b>c</b>	0.40	0.63	0.016	0.025
<b>D</b>	15.85	16.15	0.624	0.636
<b>D1</b>	9.53	9.83	0.375	0.387
<b>E</b>	10.35	10.65	0.407	0.419
<b>e</b>	2.54		0.100	
<b>e1</b>	5.08		0.200	
<b>N</b>	3		3	
<b>H</b>	29.45	29.75	1.159	1.171
<b>L</b>	13.45	13.75	0.530	0.541
<b>L1</b>	3.15	3.45	0.124	0.136
<b>pP</b>	2.95	3.20	0.116	0.126
<b>Q</b>	3.15	3.50	0.124	0.138

REFERENCE	.J..
SCALE	0 2.5 5mm
EUROPEAN PROJECTION	
ISSUE DATE	08-01-2007
FILE	TO220_2

**Published by**

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81726 Munich, Germany  
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